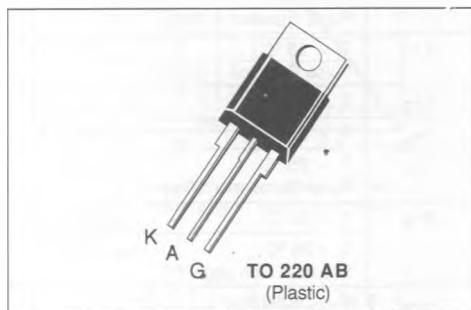


THYRISTORS FOR OVERVOLTAGE PROTECTION

- GLASS PASSIVATED CHIP
- HIGH STABILITY AND RELIABILITY
- HIGH SURGE CAPABILITY
- HIGH dI/dt RATING

DESCRIPTION

SCR designed for overvoltage protection in crowbar circuits.



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
$I_{T(RMS)}$	RMS on-state Current (1)	$T_c = 75^\circ\text{C}$	12	A
$I_{T(AV)}$	Mean on-state Current (1)	$T_c = 75^\circ\text{C}$	8	A
I_{TSM}	Non Repetitive Surge Peak on-state Current (T_j initial = 25 °C) (2)	$t = 8.3 \text{ ms}$	315	A
		$t = 10 \text{ ms}$	300	
I^2t	I^2t Value for Fusing	$t = 10 \text{ ms}$	450	A^2s
I_{TM}	Non Repetitive Surge Peak on-state Current (T_j initial = 25 °C) (5)	$t = 1 \text{ ms}$	750	A
dI/dt	Critical Rate of Rise of on-state Current (3)		100	$\text{A}/\mu\text{s}$
T_{stg} T_j	Storage and Operating Junction Temperature Range		-40 to 125	$^\circ\text{C}$
			-40 to 125	$^\circ\text{C}$

Symbol	Parameter	TYP212	TYP512	TYP1012	TYP2012	Unit
V_{DRM} V_{RRM}	Repetitive Peak off-state Voltage (4)	25	50	100	200	V

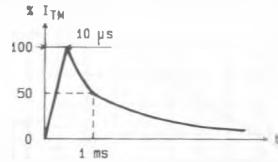
(1) Single phase circuit, 180° conduction angle.

(5) Exponential pulse wave form 10/1000

(2) Half sine wave

(3) $I_g = 300 \text{ mA}$ $dI/dt = 1 \text{ A}/\mu\text{s}$

(4) $T_j = 125^\circ\text{C}$



DBBTHYPOTEC1

THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction-case for D.C.		4.74	$^\circ\text{C}/\text{W}$
$R_{th(j-a)}$	Junction-ambient		60	$^\circ\text{C}/\text{W}$

GATE CHARACTERISTICS (maximum values)

$$P_{GM} = 20 \text{ W } (t_D = 20 \mu\text{s})$$

$$I_{FGM} = 2 \text{ A} \quad (t_0 = 20 \text{ } \mu\text{s})$$

$$V_{BGM} = 5 \text{ V}$$

$$P_G(AV) = 0.5 \text{ W}$$

$$V_{FGM} = 10 \text{ V } (t_0 = 20 \mu\text{s})$$

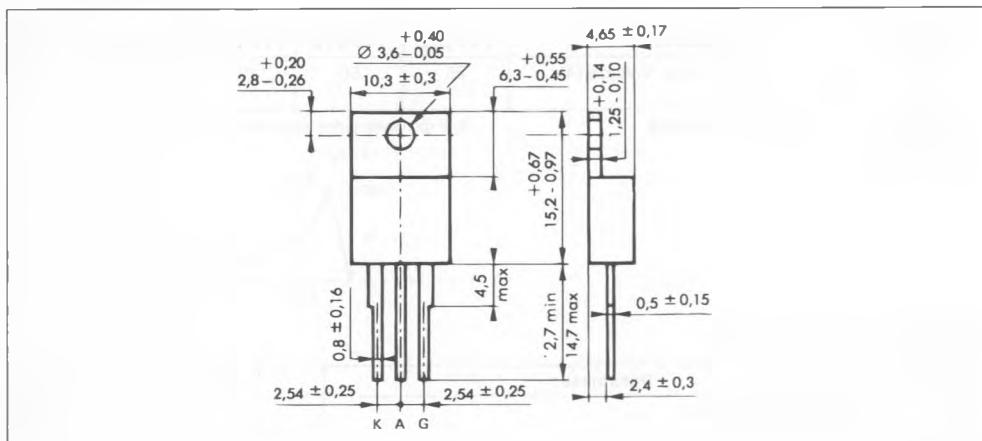
ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions			Min.	Typ.	Max.	Unit
I _{GT}	T _j = 25 °C Pulse Duration > 20 µs	V _D = 12 V	R _L = 33 Ω			30	mA
V _{GT}	T _j = 25 °C Pulse Duration > 20 µs	V _D = 12 V	R _L = 33 Ω			1.5	V
V _{GD}	T _j = 125 °C	V _D = V _{DRM}	R _L = 3.3 kΩ	0.2			V
I _H	T _j = 25 °C	I _T = 100 mA	Gate Open			50	mA
I _L	T _j = 25 °C Pulse Duration > 20 µs	V _D = 12 V	I _G = 60 mA		60		mA
V _{TM}	T _j = 25 °C	I _{TM} = 50 A	t _p = 10 ms			1.5	V
	T _j = 25 °C See note 5 on page 1/5.	I _{TM} = 750 A	t = 10 ms		6		
I _{DRM}	V _{DRM} Specified		T _j = 25 °C			0.01	mA
			T _j = 125 °C			2	
I _{RRM}	V _{RRM} Specified		T _j = 25 °C			0.01	mA
			T _j = 125 °C			2	
t _{gt}	T _j = 25 °C I _G = 200 mA	V _D = V _{DRM} dI _G /dt = 1.5 A/µs	I _T = 50 A		1		µs
t _q	T _j = 125 °C V _D = 67 % V _{DRM} Gate Open	I _T = 50 A dI/dt = 30 A/µs	V _R = 25 V dv/dt = 50 V/µs		100		µs
dv/dt*	T _j = 125 °C Linear Slope up to V _D	Gate Open = 67 % V _{DRM}		200			V/µs

* For higher guaranteed values, please consult us.

PACKAGE MECHANICAL DATA

TO 220 AB Plastic



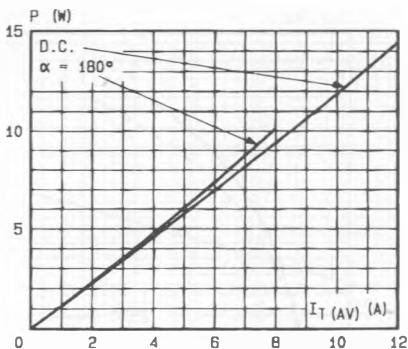


Fig.1 - Maximum average power dissipation versus average on-state current (half sine wave 50 Hz and D.C.).

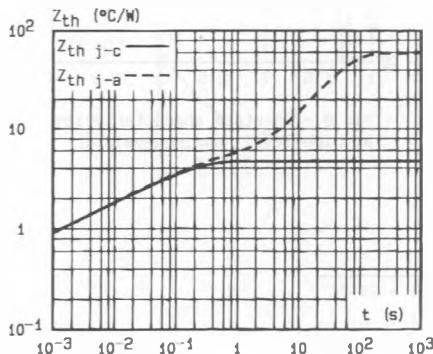


Fig.3 - Thermal transient impedance junction to case and junction to ambient versus pulse duration.

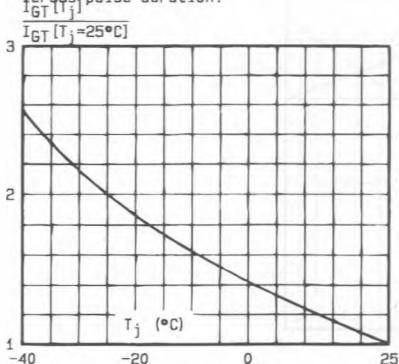


Fig.5 - Relative variation of gate trigger current versus junction temperature.

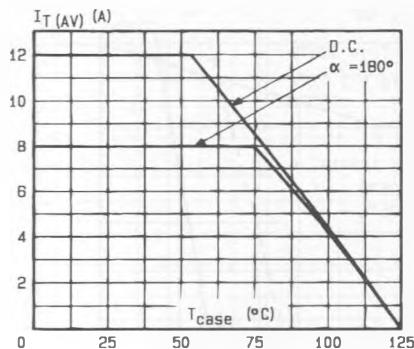


Fig.2 - Maximum average on-state current versus case temperature (half sine wave 50 Hz and D.C.).

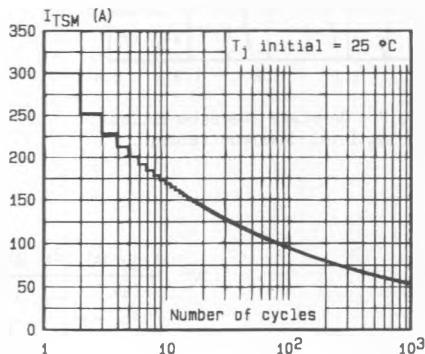


Fig.4 - Non repetitive surge peak on-state current versus number of cycles.

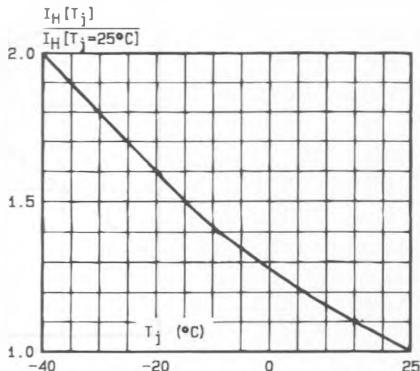


Fig.6 - Relative variation of holding current versus junction temperature.

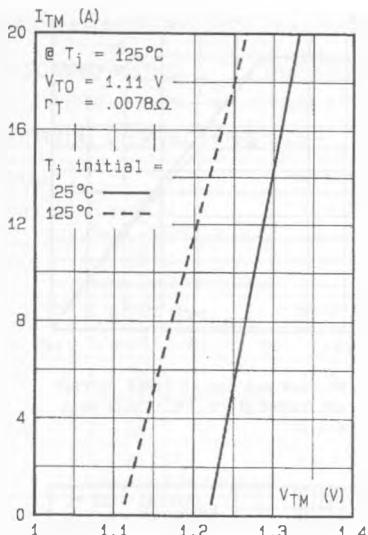


Fig.7 - On-state characteristics at low level (maximum values).

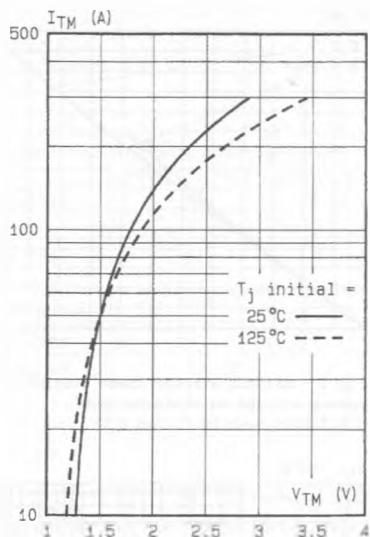


Fig.8 - On-state characteristics at high level (maximum values).

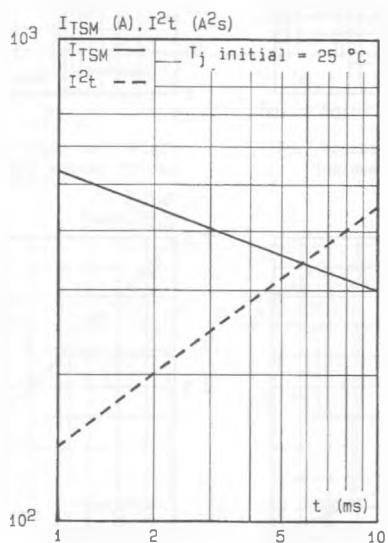


Fig.9 - Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10\text{ ms}$, and corresponding value of I^2t .

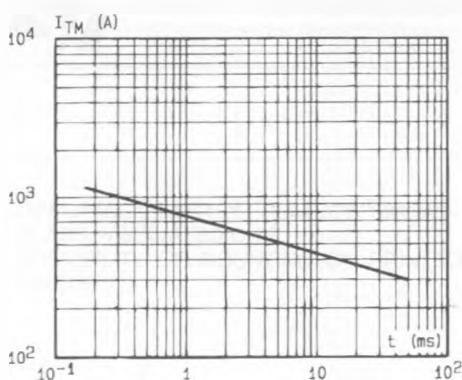


Fig.10 - Peak capacitor discharge current versus pulse width.

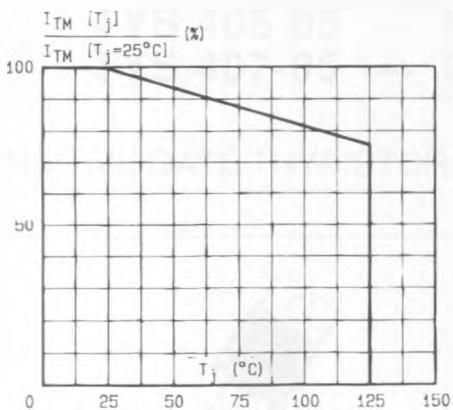


Fig.11 - Allowable peak capacitor discharge current versus initial junction temperature.

